1.2 Performance Overview

Table 1.1 outlines the Functions and Specifications for R8C/24 Group and Table 1.2 outlines the Functions and Specifications for R8C/25 Group.

Table 1.1 Functions and Specifications for R8C/24 Group

Item			Specification
CPU	Number of fundamental instructions		89 instructions
	Minimum instruction execution time		50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) 100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V) 200 ns (f(XIN) = 5 MHz, VCC = 2.2 to 5.5 V)
	Operating mode		Single-chip
	Address space		1 Mbyte
	Memory capacity		Refer to **Table 1.3 Product Information for R8C/24 Group**
Peripheral Functions	Ports		I/O ports: 41 pins, Input port: 3 pins
	LED drive ports		I/O ports: 8 pins
	Timers		Timer RA: 8 bits × 1 channel Timer RB: 8 bits × 1 channel (Each timer equipped with 8-bit prescaler) Timer RD: 16 bits × 2 channels (Input capture and output compare circuits) Timer RE: With real-time clock and compare match function
	Serial interfaces		2 channels (UART0, UART1) Clock synchronous serial I/O, UART
	Clock synchronous serial interface		1 channel I²C bus Interface(1) Clock synchronous serial I/O with chip select
	LIN module		Hardware LIN: 1 channel (timer RA, UART0)
	A/D converter		10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer		15 bits × 1 channel (with prescaler) Reset start selectable
	Interrupts		Internal: 11 sources, External: 5 sources, Software: 4 sources, Priority levels: 7 levels
	Clock	Clock generation circuits	3 circuits • XIN clock generation circuit (with on-chip feedback resistor) • On-chip oscillator (high speed, low speed) High-speed on-chip oscillator has a frequency adjustment function • XCIN clock generation circuit (32 kHz)
			Real-time clock (timer RE)
	Oscillation stop detection function		XIN clock oscillation stop detection function
	Voltage detection circuit		On-chip
	Power-on reset circuit		On-chip
Electrical Characteristics	Supply voltage		VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz) VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz) VCC = 2.2 to 5.5 V (f(XIN) = 5 MHz)
	Current consumption		Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz) Typ. 6 mA (VCC = 3.0 V, f(XIN) = 10 MHz) Typ. 2.0 µA (VCC = 3.0 V, wait mode (f(XCIN) = 32 kHz) Typ. 0.7 µA (VCC = 3.0 V, stop mode)
Flash Memory	Programming and erasure voltage		VCC = 2.7 to 5.5 V
	Programming and erasure endurance		100 times
Operating Ambient Temperature			-20 to 85°C (N version)
			-40 to 85°C (D version)(2)
			-20 to 105°C (Y version)(3)
Package			52-pin molded-plastic LQFP
			64-pin molded-plastic FLGA

NOTES:
1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
2. Specify the D version if D version functions are to be used.
3. Please contact Renesas Technology sales offices for the Y version.

Table 1.2 Functions and Specifications for R8C/25 Group

Item			Specification
CPU	Number of fundamental instructions		89 instructions
	Minimum instruction execution time		50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) 100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V) 200 ns (f(XIN) = 5 MHz, VCC = 2.2 to 5.5 V)
	Operating mode		Single-chip
	Address space		1 Mbyte
	Memory capacity		Refer to **Table 1.4 Product Information for R8C/25 Group**
Peripheral Functions	Ports		I/O ports: 41 pins, Input port: 3 pins
	LED drive ports		I/O ports: 8 pins
	Timers		Timer RA: 8 bits × 1 channel Timer RB: 8 bits × 1 channel (Each timer equipped with 8-bit prescaler) Timer RD: 16 bits × 2 channels (Input capture and output compare circuits) Timer RE: With real-time clock and compare match function
	Serial interface		2 channels (UART0, UART1) Clock synchronous serial I/O, UART
	Clock synchronous serial interface		1 channel I²C bus Interface(1) Clock synchronous serial I/O with chip select
	LIN module		Hardware LIN: 1 channel (timer RA, UART0)
	A/D converter		10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer		15 bits × 1 channel (with prescaler) Reset start selectable
	Interrupts		Internal: 11 sources, External: 5 sources, Software: 4 sources, Priority levels: 7 levels
	Clock	Clock generation circuits	3 circuits • XIN clock generation circuit (with on-chip feedback resistor) • On-chip oscillator (high speed, low speed) High-speed on-chip oscillator has a frequency adjustment function • XCIN clock generation circuit (32 kHz)
			Real-time clock (timer RE)
	Oscillation stop detection function		XIN clock oscillation stop detection function
	Voltage detection circuit		On-chip
	Power-on reset circuit		On-chip
Electrical Characteristics	Supply voltage		VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz) VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz) VCC = 2.2 to 5.5 V (f(XIN) = 5 MHz)
	Current consumption		Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz) Typ. 6 mA (VCC = 3.0 V, f(XIN) = 10 MHz) Typ. 2.0 µA (VCC = 3.0 V, wait mode (f(XCIN) = 32 kHz) Typ. 0.7 µA (VCC = 3.0 V, stop mode)
Flash memory	Programming and erasure voltage		VCC = 2.7 to 5.5 V
	Programming and erasure endurance		1,0000 times (data flash)
			1,000 times (program ROM)
Operating Ambient Temperature			-20 to 85°C (N version)
			-40 to 85°C (D version)(2)
			-20 to 105°C (Y version)(3)
Package			52-pin molded-plastic LQFP
			64-pin molded-plastic FLGA

NOTES:
1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
2. Specify the D version if D version functions are to be used.
3. Please contact Renesas Technology sales offices for the Y version.

1.3 Block Diagram

Figure 1.1 shows a Block Diagram.

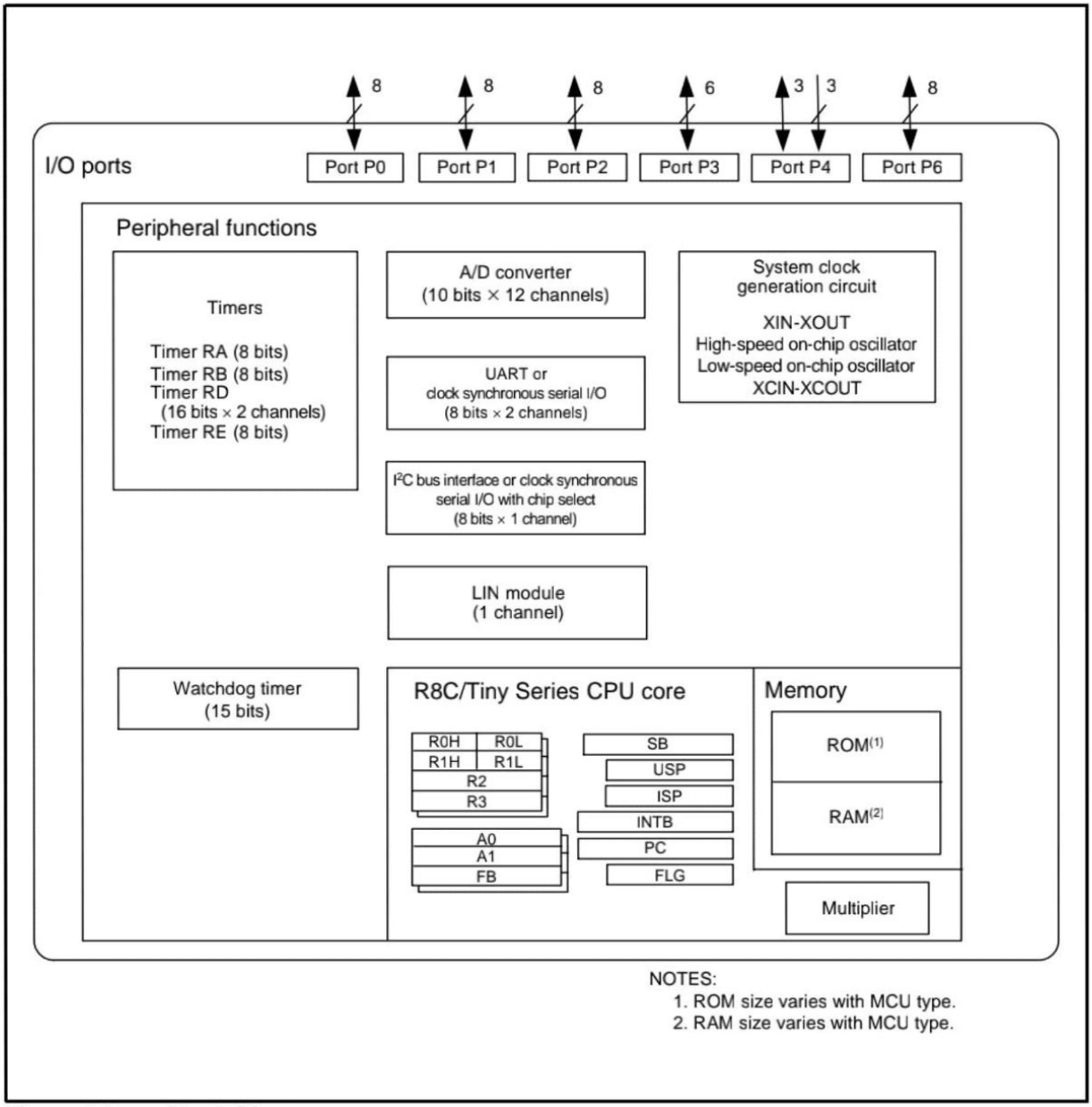


Figure 1.1 Block Diagram

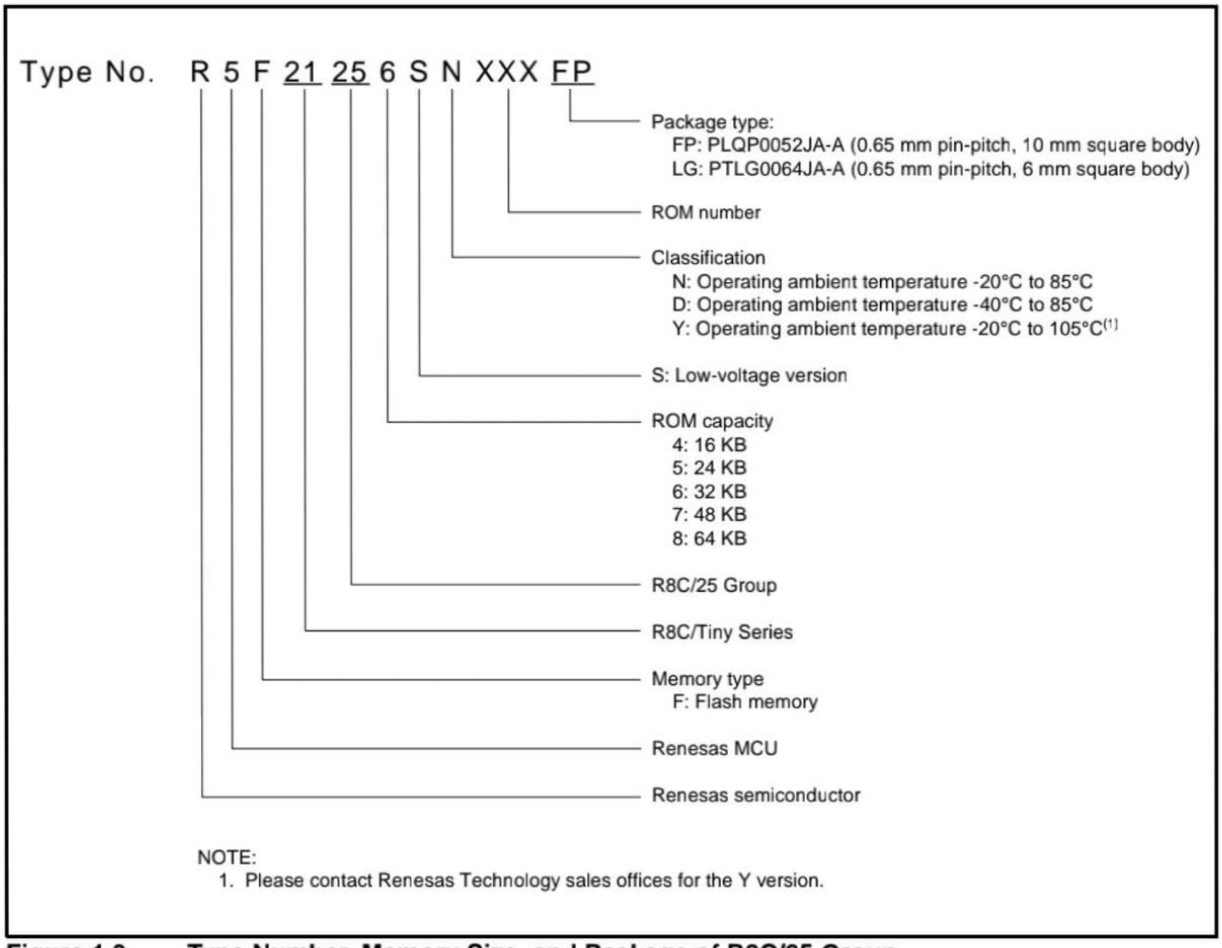


Figure 1.3 Type Number, Memory Size, and Package of R8C/25 Group

1.5 Pin Assignments

Figure 1.4 shows PLQP0052JA-A Package Pin Assignments (Top View). Figure 1.5 shows PTLG0064JA-A Package Pin Assignments.

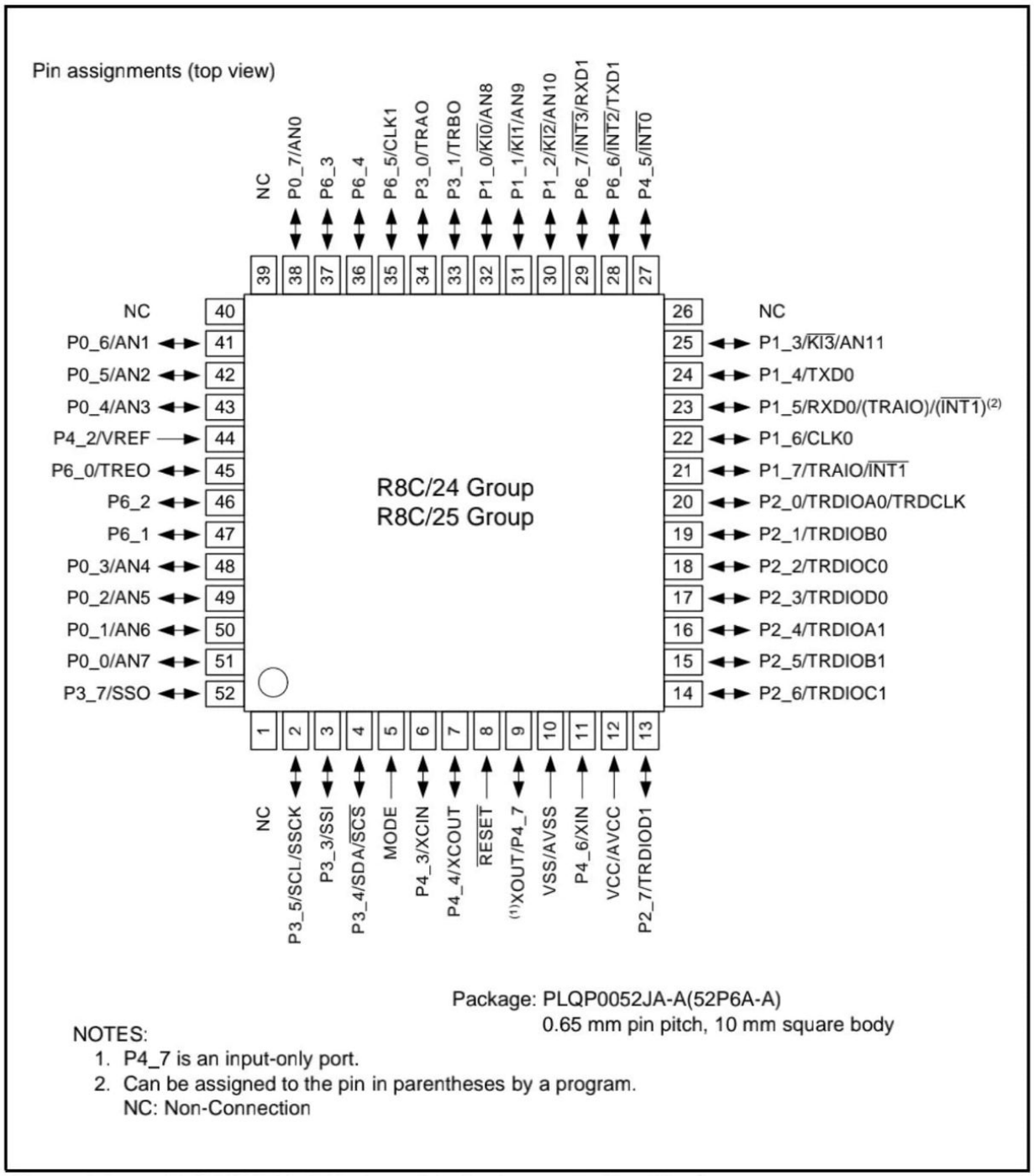


Figure 1.4 PLQP0052JA-A Package Pin Assignments (Top View)

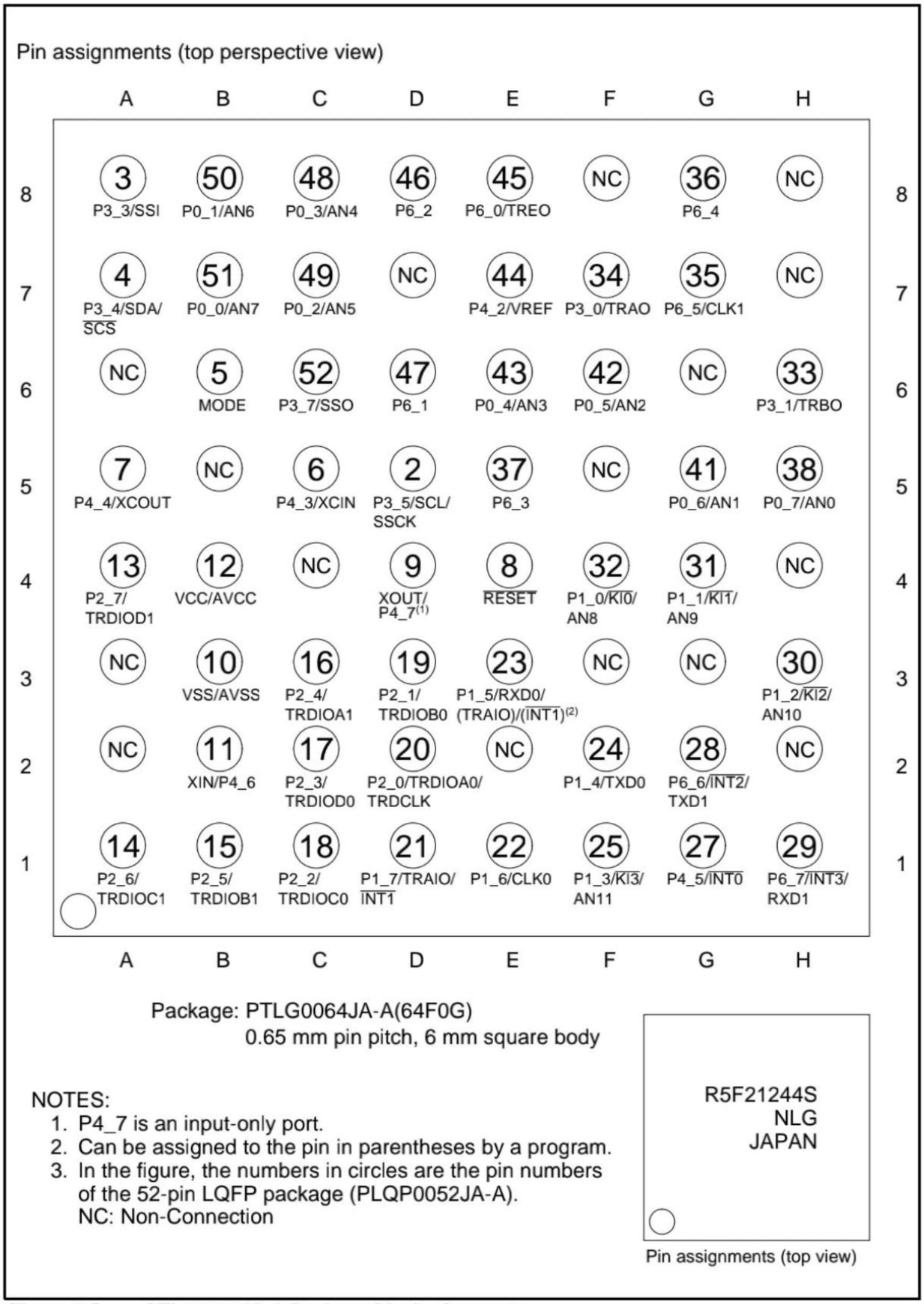


Figure 1.5 PTLG0064JA-A Package Pin Assignments

1.6 Pin Functions

Table 1.5 lists Pin Functions.

Table 1.5 Pin Functions

Type	Symbol	I/O Type	Description
Power supply input	VCC, VSS	I	Apply 2.2 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	I	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	$\overline{\text{RESET}}$	I	Input "L" on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an external clock, input it to the XIN pin and leave the XOUT pin open.
XIN clock output	XOUT	O	
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins. To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
XCIN clock output	XCOUT	O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT0}}$ to $\overline{\text{INT3}}$	I	$\overline{\text{INT}}$ interrupt input pins. $\overline{\text{INT0}}$ is timer RD input pin. $\overline{\text{INT1}}$ is timer RA input pin.
Key input interrupt	$\overline{\text{KI0}}$ to $\overline{\text{KI3}}$	I	Key input interrupt input pins
Timer RA	TRAIO	I/O	Timer RA I/O pin
	TRAO	O	Timer RA output pin
Timer RB	TRBO	O	Timer RB output pin
Timer RD	TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOC0, TRDIOC1, TRDIOD0, TRDIOD1	I/O	Timer RD I/O ports
	TRDCLK	I	External clock input pin
Timer RE	TREO	O	Divided clock output pin
Serial interface	CLK0, CLK1	I/O	Transfer clock I/O pin
	RXD0, RXD1	I	Serial data input pins
	TXD0, TXD1	O	Serial data output pins
I^2C bus interface	SCL	I/O	Clock I/O pin
	SDA	I/O	Data I/O pin
Clock synchronous serial I/O with chip select	SSI	I/O	Data I/O pin
	$\overline{\text{SCS}}$	I/O	Chip-select signal I/O pin
	SSCK	I/O	Clock I/O pin
	SSO	I/O	Data I/O pin
Reference voltage input	VREF	I	Reference voltage input pin to A/D converter
A/D converter	AN0 to AN11	I	Analog input pins to A/D converter
I/O port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0, P3_1, P3_3 to P3_5, P3_7, P4_3 to P4_5, P6_0 to P6_7	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P2_0 to P2_7 also function as LED drive ports.
Input port	P4_2, P4_6, P4_7	I	Input-only ports

I: Input O: Output I/O: Input and output

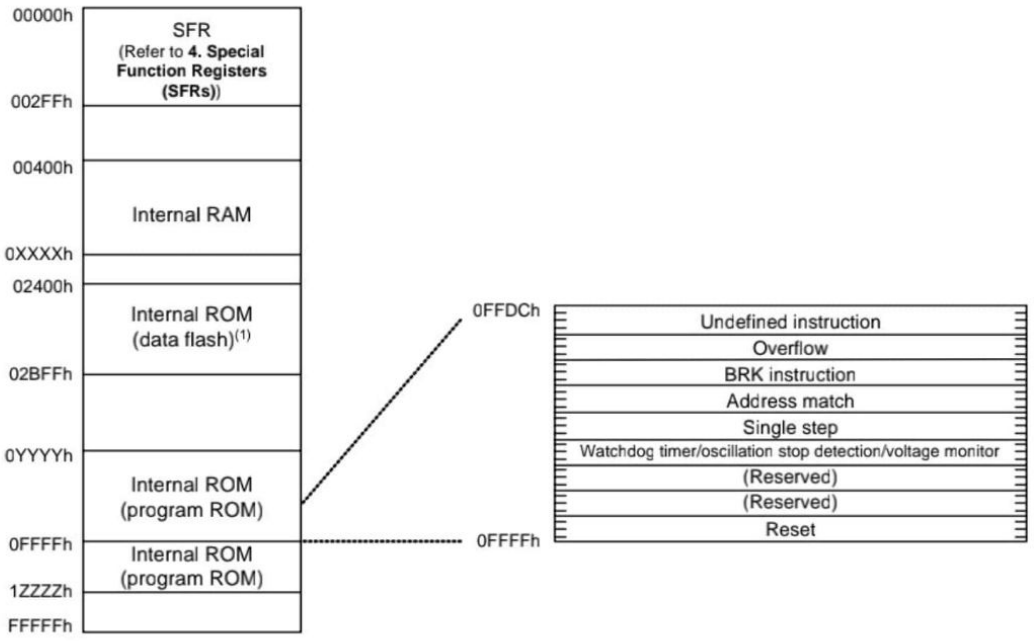
Table 1.6 Pin Name Information by Pin Number

Pin Number	Control Pin	Port	I/O Pin Functions for of Peripheral Modules					
			Interrupt	Timer	Serial Interface	Clock Synchronous Serial I/O with Chip Select	I^2C bus Interface	A/D Converter
2		P3_5				SSCK	SCL	
3		P3_3				SSI		
4		P3_4				$\overline{SCS}$	$\overline{SDA}$	
5	MODE							
6	XCIN	P4_3						
7	XCOUT	P4_4						
8	$\overline{RESET}$							
9	XOUT	P4_7						
10	VSS/AVSS							
11	XIN	P4_6						
12	VCC/AVCC							
13		P2_7		TRDIOD1				
14		P2_6		TRDIOC1				
15		P2_5		TRDIOB1				
16		P2_4		TRDIOA1				
17		P2_3		TRDIOD0				
18		P2_2		TRDIOC0				
19		P2_1		TRDIOB0				
20		P2_0		TRDIOA0/TRDCLK				
21		P1_7	$\overline{INT1}$	TRAIO				
22		P1_6			CLK0			
23		P1_5	$\overline{(INT1)}$(1)	(TRAIO)(1)	RXD0			
24		P1_4			TXD0			
25		P1_3	$\overline{KI3}$					AN11
27		P4_5	$\overline{INT0}$	$\overline{INT0}$				
28		P6_6	$\overline{INT2}$		TXD1			
29		P6_7	$\overline{INT3}$		RXD1			
30		P1_2	$\overline{KI2}$					AN10
31		P1_1	$\overline{KI1}$					AN9
32		P1_0	$\overline{KI0}$					AN8
33		P3_1		TRBO				
34		P3_0		TRAO				
35		P6_5			CLK1			
36		P6_4						
37		P6_3						
38		P0_7						AN0
41		P0_6						AN1
42		P0_5						AN2
43		P0_4						AN3
44	VREF	P4_2						
45		P6_0		TREO				
46		P6_2						
47		P6_1						
48		P0_3						AN4
49		P0_2						AN5
50		P0_1						AN6
51		P0_0						AN7
52		P3_7				SSO		

NOTE:
1. Can be assigned to the pin in parentheses by a program.

3.2 R8C/25 Group

Figure 3.2 is a Memory Map of R8C/25 Group. The R8C/25 group has 1 Mbyte of address space from addresses 00000h to FFFFFh.
The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM area is allocated addresses 04000h to 0FFFFh.
The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.
The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.
The internal RAM area is allocated higher addresses, beginning with address 00400h. For example, a 2-Kbyte internal RAM is allocated addresses 00400h to 00BFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.
Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.



NOTES:
1. Data flash block A (1 Kbyte) and B (1 Kbyte) are shown.
2. The blank regions are reserved. Do not access locations in these regions.

Part Number	Internal ROM			Internal RAM	
	Size	Address 0YYYYh	Address 1ZZZZh	Size	Address 0XXXXh
R5F21254SNFP, R5F21254SNXXXFP, R5F21254SDFP, R5F21254SDXXXFP, R5F21254SNLG, R5F21254SNXXXLG	16 Kbytes	0C000h	–	1 Kbyte	007FFh
R5F21255SNFP, R5F21255SNXXXFP, R5F21255SDFP, R5F21255SDXXXFP	24 Kbytes	0A000h	–	2 Kbytes	00BFFh
R5F21256SNFP, R5F21256SNXXXFP, R5F21256SDFP, R5F21256SDXXXFP, R5F21256SNLG, R5F21256SNXXXLG	32 Kbytes	08000h	–	2 Kbytes	00BFFh
R5F21257SNFP, R5F21257SNXXXFP, R5F21257SDFP, R5F21257SDXXXFP	48 Kbytes	04000h	–	2.5 Kbytes	00DFFh
R5F21258SNFP, R5F21258SNXXXFP, R5F21258SDFP, R5F21258SDXXXFP	64 Kbytes	04000h	13FFFh	3 Kbytes	00FFFh

Figure 3.2 Memory Map of R8C/25 Group